

iMAPS New England – 50th Symposium & Expo

May 7, 2024

**The Leading Regional Symposium Dedicated to
Microelectronics, Assembly and Packaging
at**

**Boxboro Regency Hotel & Conference Center
Boxborough, Massachusetts**

CALL-FOR-ABSTRACTS

**The Symposium Technical Committee is soliciting
Abstracts for Oral & Interactive Poster Presentations
on all aspects of Microelectronics Assembly & Packaging
Special Focus on Advanced Packaging
Microsystems & Microfabrication & New Materials**



Please e-mail your 100-250 word abstract to: imapsne-abstracts@imapsne.org

Please use your personal or University e-mail address to avoid company filters!

Deadlines for Submissions – *February 23, 2024*



also

EarlyBird II Exhibitor Registration is OPEN

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